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PATENT

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Signature

Signature

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Richard N. ELLSON et al.

Serial No.: 09/964,215

Filing Date: September 25, 2001

Group Art Unit: 1627

Examiner: Maurie Baker TECH

TECH CENTER 1600/2900

RECEIVED

DEC 0 5 2002

Title: HIGH DENSITY MOLECULAR ARRAYS ON POROUS SURFACES

COMMUNICATION

Commissioner for Patents Washington, DC 20231

Sir:

Applicants wish to call the Examiner's attention to U.S. Patent Application Serial No. 09/735,709 to Williams et al., entitled "ACOUSTICALLY MEDIATED FLUID TRANSFER METHOD AND USES THEREOF," filed December 12, 2000. The Williams et al. application published on July 18, 2002 as US 2002/0094582 A1, and a copy of the published application is submitted herewith for the Examiner's consideration. The application pertains to the use of acoustic energy in droplet formation. Please note that the Williams et al. patent publication should not represent prior art to the present claims, insofar as the effective filing date of this case, September 25, 2000, precedes the filing date of the Williams et al. application.

Respectfully submitted,

By:

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